ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATION CONNECTING	. Bannockh	ourn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su compasses	bstances v s all lower	vithin the manufactule level materials for v	urer listed which the	item. Note: manufacture	if the item is an as r has engineering	sembly with low responsibility.	
	PressureIPC Web Site for Information on IPC-1752 StandardForm Thttp://www.ipc.org/IPC-175xDistribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and M					Afg Informat	tion			
Supplier Information														
ompany name* Company			ny unique ID			Unique ID Authority				Respon	Response Date*			
emi										2023-06-08				
Contact Name	Title - Contact				:	Phone - Contact*				Email	Email - Contact*			
duct-Env-Stewards Product Enviro Compliance				NA			Product-Env-Stewards@onsemi.com							
uthorized Representative* Title - Representative			sentative		Phone - Repres	e - Representative*			Email	Email - Representative*				
Product-Env-Stewards Product En			t Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	FOD832	COD8321R2V SO5 3A GD T		&R VDE		2023-06-08		Pl	PBB		197.151	mg	Each	
Aanufacturing Proccess Informatio	n							·						
Terminal Plating / Grid Array Mater	rial T	Terminal Base Alloy J		J-STD-020 MS	L Rating	Peak Proce	ocess Body Temperature Max Time at Peak		k Tempera	ture Num	ber of Reflow Cyc	les		
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperature	during sol	dering is 10-3	0 seconds											
or more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	3.5	mg	Supplier	Dimethyl Siloxane	68083-19-2		3.5	mg
Die	1.131	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.071	mg
			Supplier	Silicon (Si)	7440-21-3		1.06	mg
Die Attach	0.223	mg	Supplier	Silver (Ag)	7440-22-4		0.1784	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0446	mg
Lead Frame 36.	36.392	mg	Supplier	Silver (Ag)	7440-22-4		0.2	mg
			Supplier	Zinc (Zn)	7440-66-6		0.044	mg
			Supplier	Iron (Fe)	7439-89-6		0.837	mg
			Supplier	Copper (Cu)	7440-50-8		35.3	mg
			Supplier	Phosphorus (P)	7723-14-0		0.011	mg
Mold Compound-Black	153.98	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		30.8	mg
			Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		6.16	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		35.4	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		4.62	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		77	mg
Plating	1.69	mg	Supplier	Tin (Sn)	7440-31-5		1.69	mg
Wire Bond - Au	0.235	mg	Supplier	Gold (Au)	7440-57-5		0.235	mg